# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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## Contact us

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Thyristor

## MCO150-12io1

$V_{\text{RRM}}$	=	1200 V
I <sub>tav</sub>	=	158 A
Vτ	=	1,37 V

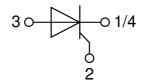
Single Thyristor

### Part number

MCO150-12io1



Backside: isolated **E**72873



### Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability

#### **Applications:**

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

#### Package: SOT-227B (minibloc)

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate: Copper
- internally DCB isolated
- Advanced power cycling

#### Terms Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you. Should you intend to use the product in aviation, in health or live endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747and per semiconductor unless otherwise specified

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# LIXYS

## MCO150-12io1

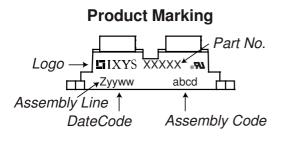
Thyristo					Ratings		
Symbol	Definition	Conditions	<b></b>	min.	typ.	max.	Uni
V <sub>RSM/DSM</sub>	max. non-repetitive reverse/forwa		$T_{VJ} = 25^{\circ}C$			1300	\
V <sub>RRM/DRM</sub>	max. repetitive reverse/forward b	0 0	$T_{VJ} = 25^{\circ}C$			1200	۷
R/D	reverse current, drain current	V <sub>R/D</sub> = 1200 V	$T_{VJ} = 25^{\circ}C$			100	μA
		V <sub>R/D</sub> = 1200 V	$T_{vJ} = 125^{\circ}C$			10	mA
V <sub>T</sub>	forward voltage drop	$I_{T} = 150 \text{ A}$	$T_{vJ} = 25^{\circ}C$			1,37	V
		$I_{T} = 300 \text{ A}$				1,78	V
		$I_{T} = 150 \text{ A}$	$T_{vJ} = 125 ^{\circ}C$			1,37	\
		I <sub>T</sub> = 300 A				1,89	١
ITAV	average forward current	$T_c = 80^{\circ}C$	$T_{vJ} = 150 ^{\circ}\text{C}$			158	A
I <sub>T(RMS)</sub>	RMS forward current	180° sine				250	A
V <sub>T0</sub>	threshold voltage		T <sub>vJ</sub> = 150°C			0,84	V
r <sub>T</sub>	slope resistance } for power l	oss calculation only				3,5	mΩ
R <sub>thJC</sub>	thermal resistance junction to cas	Se				0,2	K/W
R <sub>thCH</sub>	thermal resistance case to heatsi				0,10		K/W
P <sub>tot</sub>	total power dissipation		$T_c = 25^{\circ}C$			620	W
I <sub>TSM</sub>	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{v.i} = 45^{\circ}C$			2,00	kA
1.51	-	t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			2,16	kA
		t = 10  ms; (50  Hz),  sine	T <sub>v.i</sub> = 150°C			1,70	kA
		t = 8,3 ms; (60 Hz), sine	$V_{\rm R} = 0 V$			1,84	kA
l²t	value for fusing	t = 0,0 ms; (50 Hz), sine	$\frac{V_{\rm R}}{T_{\rm VJ}} = 45^{\circ}{\rm C}$			20,0	kA <sup>2</sup> s
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			19,4	kA <sup>2</sup> s
		t = 0.5  ms; (50  Hz),  sine t = 10  ms; (50  Hz),  sine	$T_{yJ} = 150^{\circ}C$			14,5	kA <sup>2</sup> s
		t = 8,3  ms; (60  Hz),  sine					
<u>^</u>	junction capacitance		$\frac{V_{R} = 0 V}{T_{R} = 25^{\circ}C}$		119	14,0	
C,		$V_{\rm R} = 400  \text{V}  \text{f} = 1  \text{MHz}$	$T_{\rm VJ} = 25^{\circ}C$		119	10	pF W
P <sub>GM</sub>	max. gate power dissipation	$t_{\rm P} = 30 \mu {\rm s}$	$T_c = 150 \circ C$			10	
_		t <sub>P</sub> = 300 μs				5	W
P <sub>GAV</sub>	average gate power dissipation					0,5	W
(di/dt) <sub>cr</sub>	critical rate of rise of current		epetitive, $I_{T} = 450 \text{ A}$			150	A/μs
		$t_{\rm P}$ = 200 µs; di <sub>G</sub> /dt =0,45 A/µs; -					
			on-repet., $I_{T} = 150 \text{ A}$				A/μs
(dv/dt) <sub>cr</sub>	critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	$T_{vJ} = 150^{\circ}C$			1000	V/µs
		$R_{GK} = \infty$ ; method 1 (linear volta					1
V <sub>GT</sub>	gate trigger voltage	$V_{D} = 6 V$	$T_{vJ} = 25^{\circ}C$			1,4	V
			$T_{vJ} = -40 ^{\circ}\text{C}$			1,6	V
I <sub>GT</sub>	gate trigger current	$V_{D} = 6 V$	$T_{vJ} = 25^{\circ}C$			150	mA
			$T_{vJ} = -40^{\circ}C$			200	mA
V <sub>gd</sub>	gate non-trigger voltage	$V_{\rm D} = \frac{2}{3} V_{\rm DRM}$	$T_{v_{J}} = 150^{\circ}C$			0,2	V
	gate non-trigger current					10	mA
I <sub>L</sub>	latching current	t <sub>p</sub> = 10 μs	$T_{vJ} = 25 ^{\circ}C$			450	mA
		l <sub>G</sub> = 0,45 A; di <sub>G</sub> /dt = 0,45 A/μs					
I <sub>H</sub>	holding current	$V_{\rm D} = 6 V R_{\rm GK} = \infty$	$T_{vJ} = 25 ^{\circ}C$			200	mA
t <sub>gd</sub>	gate controlled delay time	$V_{\rm D} = \frac{1}{2} V_{\rm DBM}$	$T_{vJ} = 25^{\circ}C$			2	με
- yu		$I_{\rm G} = 0.45 \text{A};  \text{di}_{\rm G}/\text{dt} = 0.45 \text{A}/\mu\text{s}$				_	Pro
t <sub>q</sub>	turn-off time	$V_{\rm R} = 100 \text{ V}; \ \text{I}_{\rm T} = 150 \text{ A}; \ \text{V} = 3200 \text{ A}; \ \text{A}; $			150		με
•a		$v_{\rm R} = 100 v$ , $i_{\rm T} = 100 A$ , $v = 7$	- DRM IVJ - IZJ U		150		με

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Package	Package SOT-227B (minibloc)			Ratings				
Symbol	Definition	Conditions			min.	typ.	max.	Unit
	RMS current	per terminal 1)					150	Α
T <sub>vJ</sub>	virtual junction temperature				-40		150	°C
T <sub>op</sub>	operation temperature				-40		125	°C
T <sub>stg</sub>	storage temperature				-40		150	°C
Weight						30		g
M <sub>D</sub>	mounting torque				1,1		1,5	Nm
M <sub>T</sub>	terminal torque				1,1		1,5	Nm
d <sub>Spp/App</sub>	araanaga diatanaa an aurfa	an Latriking diatanga through air	terminal to terminal	10,5	3,2			mm
d <sub>Spb/Apb</sub>	creepage distance on suna	ce   striking distance through air	terminal to backside	8,6	6,8			mm
V	isolation voltage	t = 1 second			3000			V
		t = 1 minute	50/60 Hz, RMS; liso∟ ≤ 1 mA		2500			V

<sup>1)</sup> I<sub>BMS</sub> is typically limited by the pin-to-chip resistance (1); or by the current capability of the chip (2). In case of (1) and a product with multiple pins for one chip-potential, the current capability can be increased by connecting the pins as one contact.



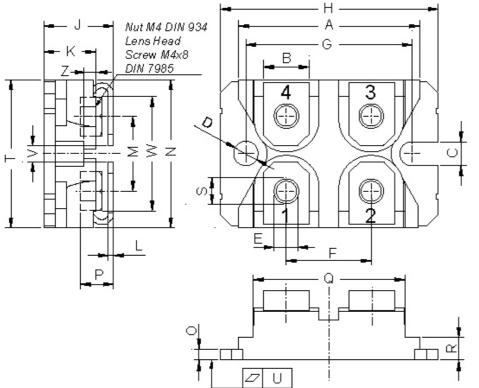
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCO150-12io1	MCO150-12io1	Tube	10	496332

Equivalent Circuits for Simulation			* on die level	$T_{VJ} = 150 \ ^{\circ}C$
	)- <u>R</u>	Thyristor		
$V_{0 max}$	threshold voltage	0,84		V
$\mathbf{R}_{0 \max}$	slope resistance *	1,6		mΩ

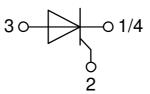
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### Outlines SOT-227B (minibloc)

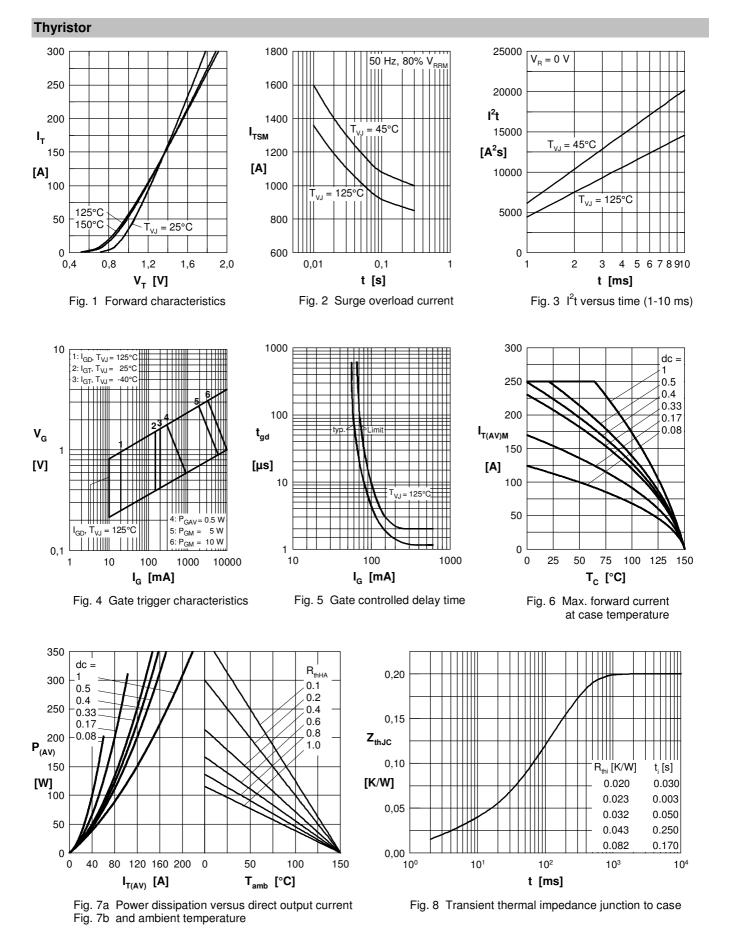


Millin		neter	Inches		
Dim.	min	max	min	max	
Α	31.50	31.88	1.240	1.255	
В	7.80	8.20	0.307	0.323	
С	4.09	4.29	0.161	0.169	
D	4.09	4.29	0.161	0.169	
Е	4.09	4.29	0.161	0.169	
F	14.91	15.11	0.587	0.595	
G	30.12	30.30	1.186	1.193	
Н	37.80	38.23	1.488	1.505	
J	11.68	12.22	0.460	0.481	
К	8.92	9.60	0.351	0.378	
L	0.74	0.84	0.029	0.033	
Μ	12.50	13.10	0.492	0.516	
Ν	25.15	25.42	0.990	1.001	
0	1.95	2.13	0.077	0.084	
Ρ	4.95	6.20	0.195	0.244	
Q	26.54	26.90	1.045	1.059	
R	3.94	4.42	0.155	0.167	
S	4.55	4.85	0.179	0.191	
Т	24.59	25.25	0.968	0.994	
U	-0.05	0.10	-0.002	0.004	
V	3.20	5.50	0.126	0.217	
W	19.81	21.08	0.780	0.830	
Ζ	2.50	2.70	0.098	0.106	



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## MCO150-12io1



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